74HC194

4-bit bidirectional universal shift register Rev. 3 — 29 November 2016

Product data sheet

General description

The 74HC194 is a 4-bit bidirectional universal shift register. The synchronous operation of the device is determined by the mode select inputs (S0, S1). In parallel load mode (S0 and S1 HIGH) data appearing on the D0 to D3 inputs, when S0 and S1 are HIGH, is transferred to the Q0 to Q3 outputs. When S0 is HIGH and S1 is LOW data is entered serially via DSL and shifted from left to right; when S0 is LOW and S1 is HIGH data is entered serially via DSR and shifted from right to left. DSR and DSL allow multistage shift right or shift left data transfers without interfering with parallel load operation. If both S0 and S1 are LOW, existing data is retained in a hold mode. Mode select and data inputs are edge-triggered, responding only to the LOW-to-HIGH transition of the clock (CP). Therefore, the only timing restriction is that the mode control and selected data inputs must be stable one set-up time prior to the positive transition of the clock pulse. When LOW, the asynchronous master reset (MR) overrides all other input conditions and forces the Q outputs LOW. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

Features and benefits 2.

- Complies with JEDEC standard no. 7A
- Input levels:
 - For 74HC194: CMOS level
- Shift-left and shift right capability
- Synchronous parallel and serial data transfer
- Easily expanded for both serial and parallel operation
- Asynchronous master reset
- Hold ('do nothing') mode
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



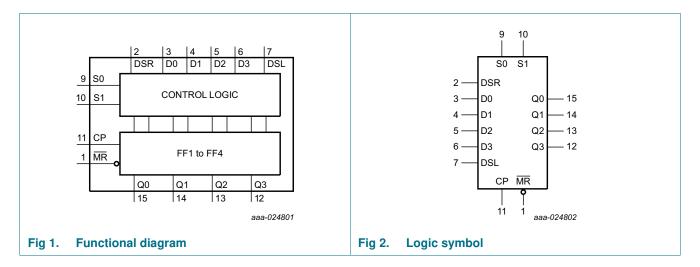
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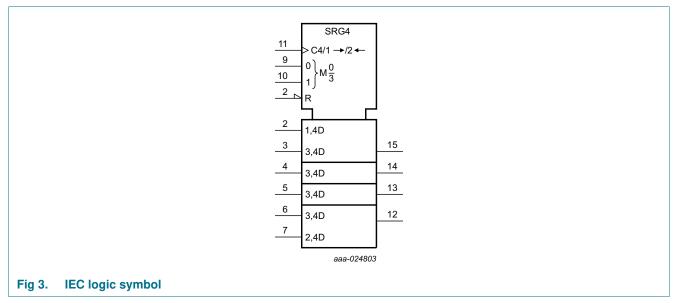
3. Ordering information

Table 1. Ordering information

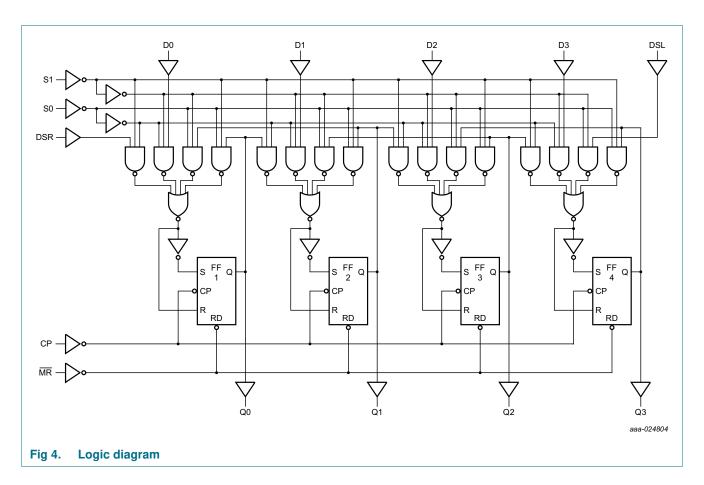
Type number	Package Package										
	Temperature range	Name	Description	Version							
74HC194D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1							
74HC194DB	-40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1							

4. Functional diagram



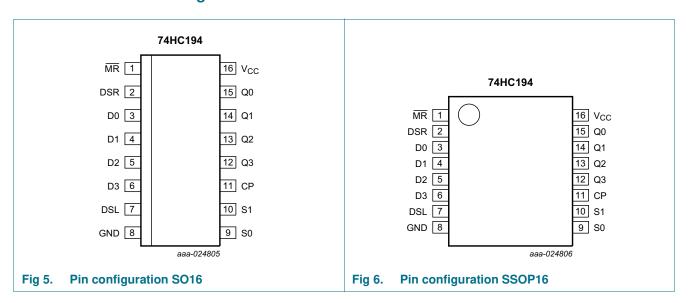


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5. Pinning information

5.1 Pinning



4-bit bidirectional universal shift register

5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
MR	1	asynchronous master reset (active LOW)
DSR	2	serial data input (shift right)
D0, D1, D2, D3	3, 4, 5, 6	parallel data inputs
DSL	7	serial data input (shift left)
GND	8	ground (0 V)
S0, S1	9, 10	mode control inputs
CP	11	clock input (LOW-to-HIGH, edge triggered)
Q0, Q1, Q2, Q3	15, 14, 13, 12	parallel outputs
V _{CC}	16	positive supply voltage

6. Functional description

Table 3. Function table[1]

Operating mode	Inputs						Outpu	Outputs			
	СР	MR	S1	S0	DSR	DSL	Dn	Q0	Q1	Q2	Q3
Reset (clear)	Х	L	Х	Х	Х	X	Х	L	L	L	L
Hold (do nothing)	Χ	Н	I	I	Х	X	Х	q0	q1	q2	q3
Shift left	↑	Н	h	I	Х	I	Х	q1	q2	q3	L
	\uparrow	Н	h	I	X	h	Х	q1	q2	q3	Н
Shift right	↑	Н	I	h	I	Х	Х	L	q0	q1	q2
	\uparrow	Н	I	h	h	Х	Х	Н	q0	q1	q2
Parallel load	↑	Н	h	h	Х	Х	dn	d0	d1	d2	d3

^[1] H = HIGH voltage level;

 $h = HIGH \ voltage \ level \ one \ set-up \ time \ prior \ to \ the \ LOW-to-HIGH \ CP \ transition;$

L = LOW voltage level;

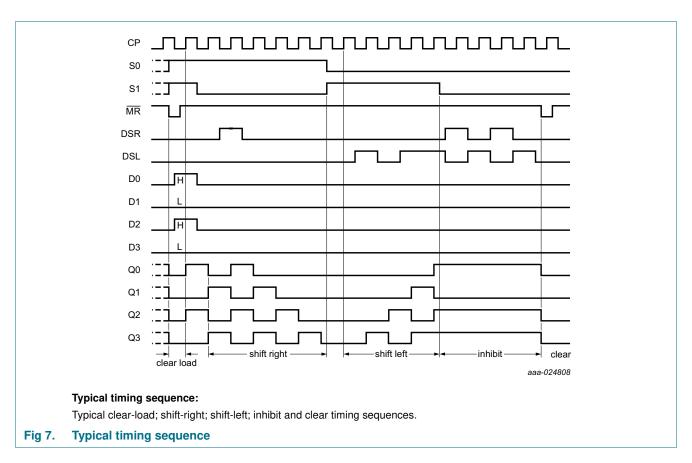
I = LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition;

q, d = lower case letters indicate the state of the referenced input (or output) one set-up time prior to the LOW-to-HIGH CP transition;

X = don't care;

 $[\]uparrow$ = LOW-to-HIGH clock transition.

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$		-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	+50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			−65	+150	°C
P _{tot}	total power dissipation	SO16 package	<u>[1]</u>	-	500	mW
		SSOP16 package	<u>[1]</u>	-	500	mW

^[1] For SO16 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K. For SSOP16 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	ns/V
		$V_{CC} = 4.5 \text{ V}$	-	1.67	139	ns/V
		$V_{CC} = 6.0 \text{ V}$	-	-	83	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μА
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80.0	-	160.0	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

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10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{pd}	propagation	CP to Qn; see Figure 8								
	delay	V _{CC} = 2.0 V	-	47	145	-	180	-	220	ns
		V _{CC} = 4.5 V	-	17	29	-	36	-	44	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	14	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	25	-	31	-	38	ns
t _{PHL}	High to LOW	MR to Qn; see Figure 9								
	propagation	V _{CC} = 2.0 V	-	39	140	-	175	-	210	ns
	delay	V _{CC} = 4.5 V	-	14	28	-	35	-	42	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	11	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	11	24	-	30	-	36	ns
t _t	transition	see Figure 8 [2]								
	time	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _W	pulse width	CP HIGH or LOW; see Figure 8								
		V _{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	5	-	17	-	20	-	ns
t _W	pulse width	MR pulse width LOW; see Figure 9								
		V _{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	5	-	17	-	20	-	ns
t _{rec}	recovery	MR to CP; see Figure 9								
	time	V _{CC} = 2.0 V	60	17	-	75	-	90	-	ns
		V _{CC} = 4.5 V	12	6	-	15	-	18	-	ns
		V _{CC} = 6.0 V	10	5	-	13	-	15	-	ns

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Table 7.Dynamic characteristics ...continuedVoltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{su}	set-up time	Dn to CP; see Figure 10								
		V _{CC} = 2.0 V	70	17	-	90	-	105	-	ns
		V _{CC} = 4.5 V	14	6	-	18	-	21	-	ns
		V _{CC} = 6.0 V	12	5	-	15	-	18	-	ns
		S0, S1 to CP; see Figure 11								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	12	6	-	17	-	20	-	ns
		DSR, DSL to CP; see Figure 10								
		V _{CC} = 2.0 V	70	19	-	90	-	105	-	ns
		V _{CC} = 4.5 V	14	7	-	18	-	21	-	ns
		V _{CC} = 6.0 V	12	6	-	15	-	18	-	ns
t _h	hold time	Dn to CP; see Figure 10								
		V _{CC} = 2.0 V	0	-14	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-5	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-4	-	0		0	-	ns
		S0, S1 to CP; see Figure 11								
		V _{CC} = 2.0 V	0	-11	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-4	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-3	-	0		0	-	ns
		DSR, DSL to CP; see Figure 10								
		V _{CC} = 2.0 V	0	-17	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-6	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	- 5	-	0		0	-	ns
f _{max}	maximum	CP; see Figure 8								
	frequency	V _{CC} = 2.0 V	6	31	-	4.8	-	4	-	MHz
		V _{CC} = 4.5 V	30	93	-	24	-	20	-	MHz
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	102	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	35	111	-	28	-	24	-	MHz

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 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	25 °C		–40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
C _{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}; f_i = 1 \text{ MHz}$	-	40	-	-	-	-	-	pF

- [1] t_{pd} is the same as t_{PHL} and t_{PLH} .
- [2] t_t is the same as t_{THL} and t_{TLH} .
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_0 = output frequency in MHz;

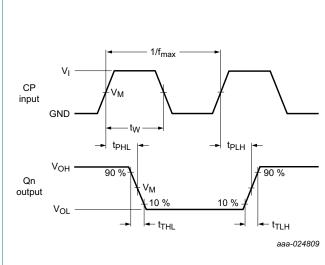
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

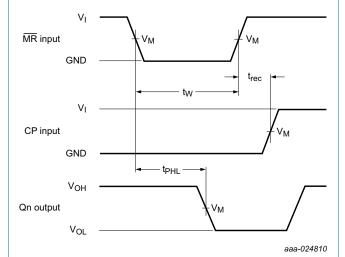
11. Waveforms



Measurement points are given in Table 8.

Logic levels V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 8. The clock (CP) to output (Qn) propagation delays, the clock pulse width, the output transition times and the maximum clock frequency

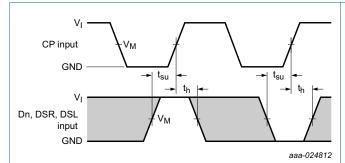


Measurement points are given in Table 8.

Logic levels V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 9. The master reset (MR) pulse width, master reset to output (Qn) propagation delays, and the master reset to clock (CP) recovery times

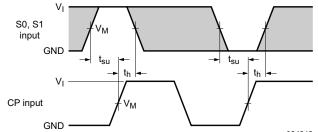
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Measurement points are given in Table 8.

The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig 10. The set-up and hold times from the data inputs (Dn, DSR and DSL) to the clock (CP)



Measurement points are given in Table 8.

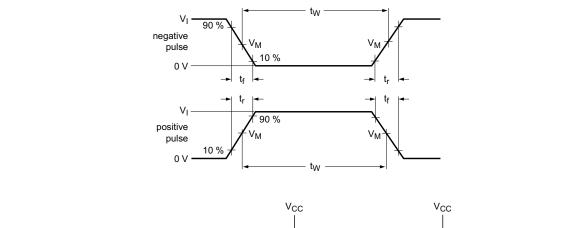
The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig 11. The set-up and hold times from the mode control inputs (Sn) to the clock input

Table 8. Measurement points

Input		Output
V _M	V _I	V _M
$0.5 \times V_{CC}$	GND to V _{CC}	$0.5 \times V_{CC}$

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G VI DUT VO RL S1 open

Test data is given in Table 9.

Test circuit definitions:

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator

C_L = Load capacitance including jig and probe capacitance

R_L = Load resistance.

S1 = Test selection switch

Fig 12. Test circuit for measuring switching times

Table 9. Test data

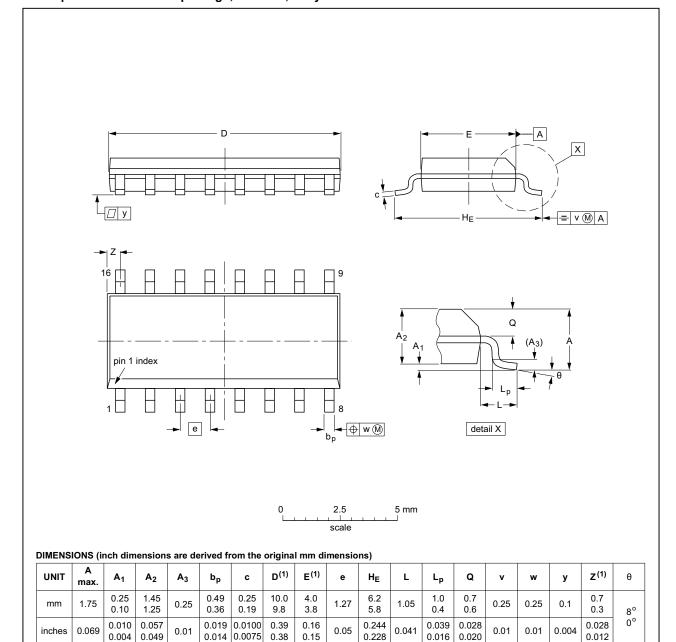
Input		Load	S1 position	
V_l t_r , t_f		CL	R _L	t _{PHL} , t _{PLH}
V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open

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12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				99-12-27 03-02-19

Fig 13. Package outline SOT109-1 (SO16)

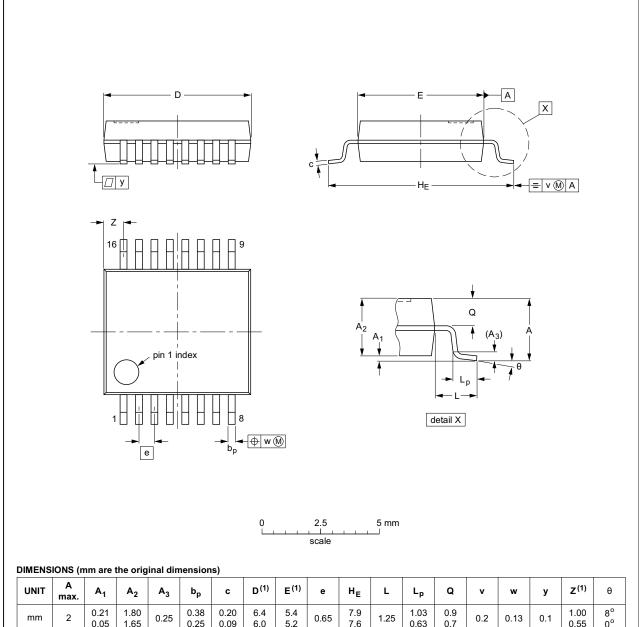
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SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



UNIT	A max.	A ₁	A ₂	A ₃	b _p	C	D ⁽¹⁾	E ⁽¹⁾	e	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT338-1		MO-150				99-12-27 03-02-19	

Fig 14. Package outline SOT338-1 (SSOP16)

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13. Abbreviations

Table 10. Abbreviations

Acronym	Description				
CMOS	Complementary Metal-Oxide Semiconductor				
DUT	Device Under Test				
ESD	ElectroStatic Discharge				
HBM	Human Body Model				
MM	Machine Model				

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC194 v.3	20161129	Product data sheet	-	74HC_HCT194 v.2			
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 						
	 Legal texts ha 	ive been adapted to the new c	ompany name where	e appropriate.			
	Type numbers	s 74HC194N, 74HCT194N and	74HCT194D remov	ved.			
74HC_HCT194 v.2	19901201	Product specification	-	-			

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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